

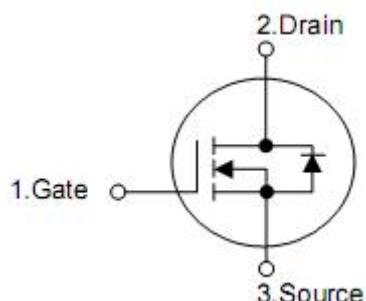
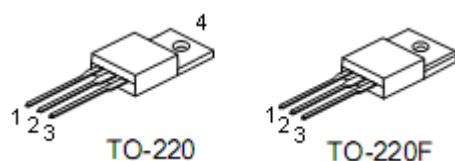
1. Description

These N-Channel enhancement mode power field effect transistors are produced using KIA's proprietary, planar, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies and electronic lamp ballasts based on half bridge.

2. Features

- 4.5A, 600V, $R_{DS(ON)} = 2.0\Omega$ @ $V_{GS} = 10V$
- Low c_{rss} (typ 8.0pF)
- Low gate charge (typ $Q_g = 16nC$)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant

3. Pin configuration



Pin	Function
1	Gate
2	Drain
3	Source
4	Drain

4. Absolute maximum ratings

(TC= 25 °C , unless otherwise specified)

Parameter		Symbol	Rating	Units
Drain-source voltage		V _{DSS}	600	V
Drain current	T _c =25 °C	I _D	4.5	A
	T _c =100 °C		2.7	A
Drain current pulsed	(note 1)	I _{DM}	18	A
Gate-source voltage		V _{GSS}	±30	V
Single pulsed avalanche energy		E _{AS}	116	mJ
Avalanche current		I _{AR}	4.5	A
Repetitive avalanche energy		E _{AR}	5.0	mJ
Peak diode recovery dv/dt		dv/dt	4.5	V/ns
Power dissipation	T _c =25 °C	P _D	50	W
	derate above 25 °C		0.4	W/°C
Operating and Storage temperature range		T _J , T _{STG}	-55 ~ +150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		T _L	300	°C

5. Thermal characteristics

Parameter	Symbol	Rating	Unit
Thermal resistance,Junction-to-case	R _{θJC}	2.3	°C/W
Thermal resistance,Junction-to-ambient	R _{θJA}	83	°C/W

6. Electrical characteristics

($T_J=25^\circ\text{C}$, unless otherwise notes)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}, T_J=25^\circ\text{C}$	600			V
		$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}, T_J=150^\circ\text{C}$		630		V
Breakdown voltage temperature coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$I_{\text{D}}=250\mu\text{A}$, referenced to 25°C		0.6		$^\circ\text{C}$
		$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$			1	μA
Zero gate voltage drain current	$I_{\text{DS}}^{\text{SS}}$	$V_{\text{DS}}=480\text{V}, T_C=125^\circ\text{C}$			10	μA
		$V_{\text{GS}}=30\text{V}, V_{\text{DS}}=0\text{V}$			100	nA
Gate-body leakage current	Forward	$V_{\text{GS}}=-30\text{V}, V_{\text{DS}}=0\text{V}$			-100	nA
	Reverse					
On characteristics						
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0		4.0	V
Static drain-source on-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=2.7\text{A}$		2.0	2.5	Ω
Forward transconductance	g_{FS}	$V_{\text{DS}}=40\text{V}, I_{\text{D}}=2.25\text{A}$ (note 4)			10	S
Dynamic characteristics						
Input capacitance	C_{iss}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1.0\text{MHz}$		780		pF
Output capacitance	C_{oss}			70		pF
Reverse transfer capacitance	C_{rss}			8		pF
Switching characteristics						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=300\text{V}, I_{\text{D}}=4.5\text{A}, R_{\text{G}}=10\Omega$ $R_{\text{D}}=60\Omega, V_{\text{GS}}=10\text{V}$ (note 4,5)		12	30	ns
Turn-on rise time	t_r			40	90	ns
Turn-off delay time	$t_{\text{d}(\text{off})}$			47	95	ns
Turn-off fall time	t_f			22	55	ns
Total gate charge	Q_g	$V_{\text{DS}}=300\text{V}, I_{\text{D}}=4.5\text{A}, V_{\text{GS}}=10\text{V}$ (note 4,5)		16		nC
Gate-source charge	Q_{gs}			4.5		nC
Gate-drain charge	Q_{gd}			7		nC
Drain-source diode characteristics and maximum rating						
Maximum continuous drain-source diode forward current	I_s				4.5	A
Maximum pulsed drain-source diode forward current	I_{SM}				18	A
Drain-source diode forward voltage	V_{SD}	$V_{\text{GS}}=0\text{V}, I_s=2.25\text{A}$			1.5	V
Reverse recovery time	t_{rr}	$V_{\text{GS}}=0\text{V}, I_s=4.5\text{A}$ $dI/dt=100\text{A}/\mu\text{s}$ (note 4)		295		ns
Reverse recovery charge	Q_{rr}			2.7		μC

Note: 1. repetitive rating:pulse width limited by maximum junction temperature

2. $I_{\text{AS}}=4.5\text{A}, L=11.5\text{mH}, V_{\text{DD}}=50\text{V}, R_{\text{G}}=25\Omega$, starting $T_J=25^\circ\text{C}$

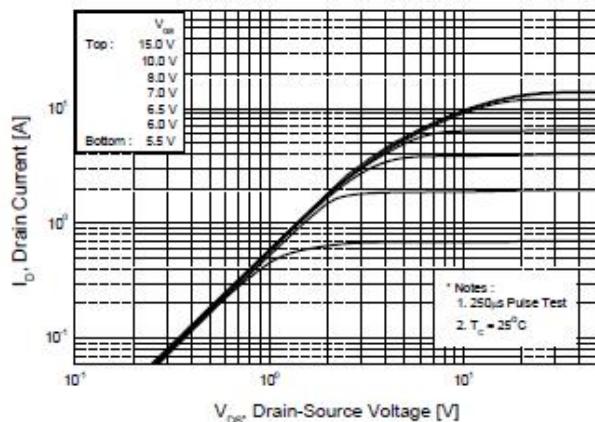
3. $I_{\text{SD}} \leq 4.5\text{A}, dI/dt \leq 100\text{A}/\mu\text{s}, V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, starting $T_J=25^\circ\text{C}$

4. Pulse test:pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$

5. Essentially independent of operating temperature Typical characteristics

7. Test circuits and waveforms

Figure 1. On-Region Characteristics



**Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage**

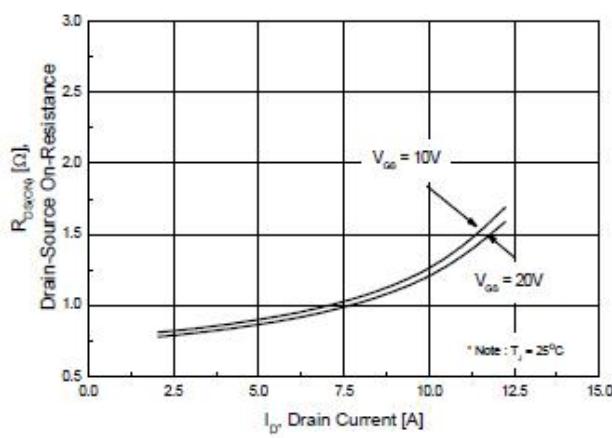


Figure 5. Capacitance Characteristics

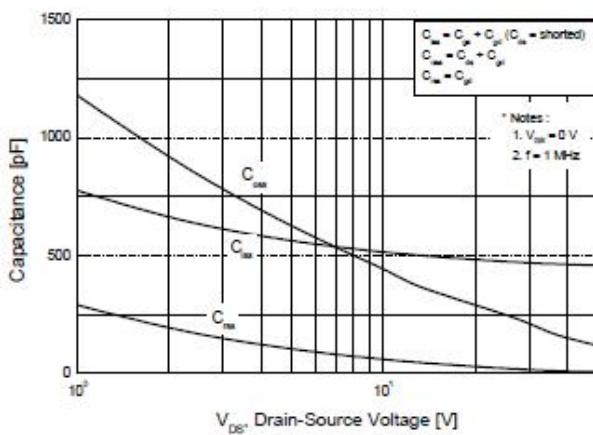
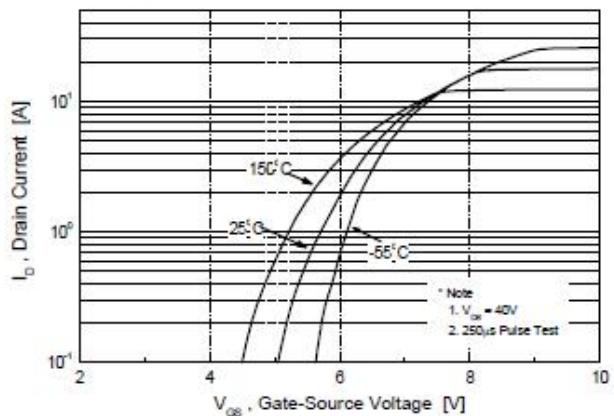


Figure 2. Transfer Characteristics



**Figure 4. Body Diode Forward Voltage
Variation vs. Source Current
and Temperature**

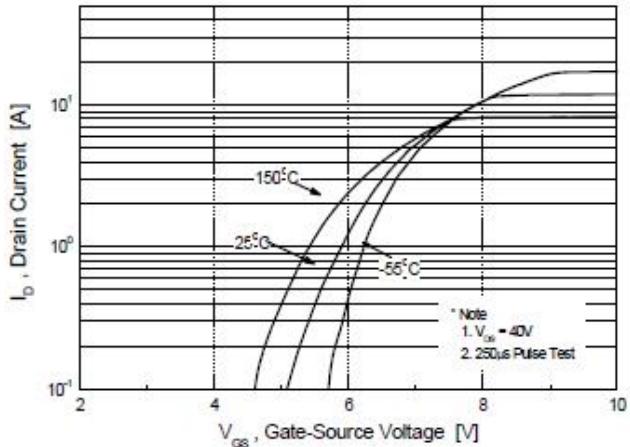


Figure 6. Gate Charge Characteristics

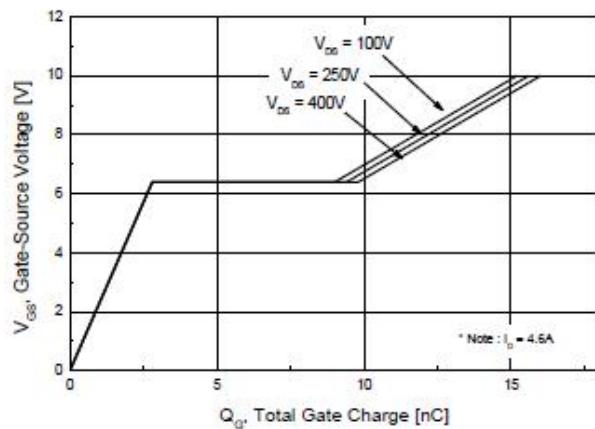


Figure 7. Breakdown Voltage Variation vs. Temperature

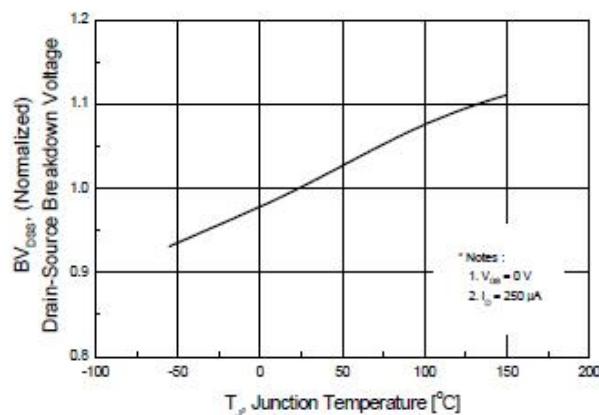


Figure 8. On-Resistance Variation vs. Temperature

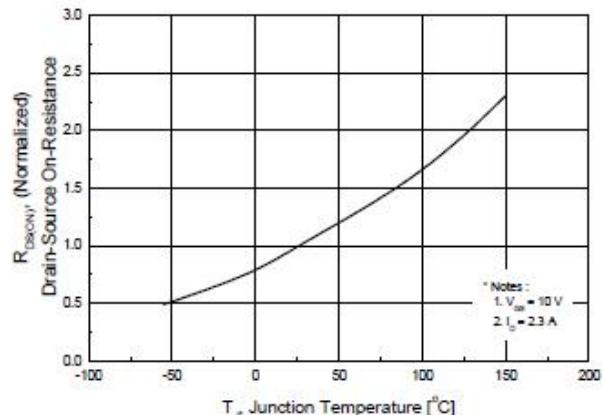


Figure 9. Maximum Safe Operating Area

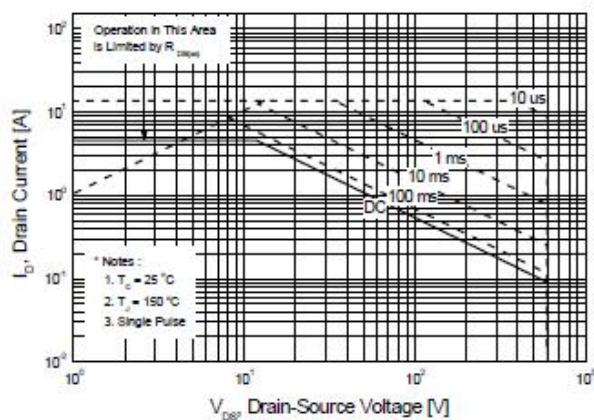


Figure 10. Maximum Drain Current vs. Case Temperature

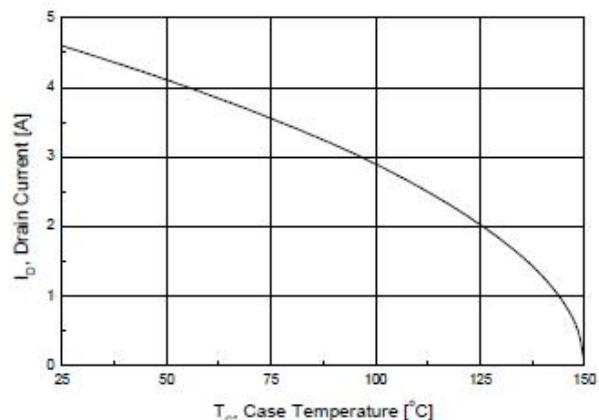
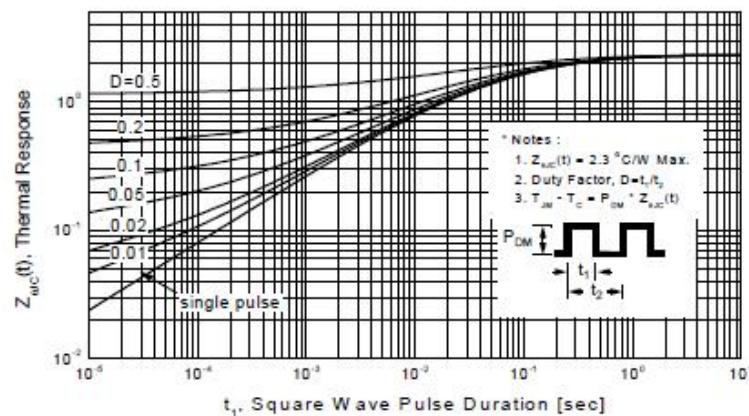
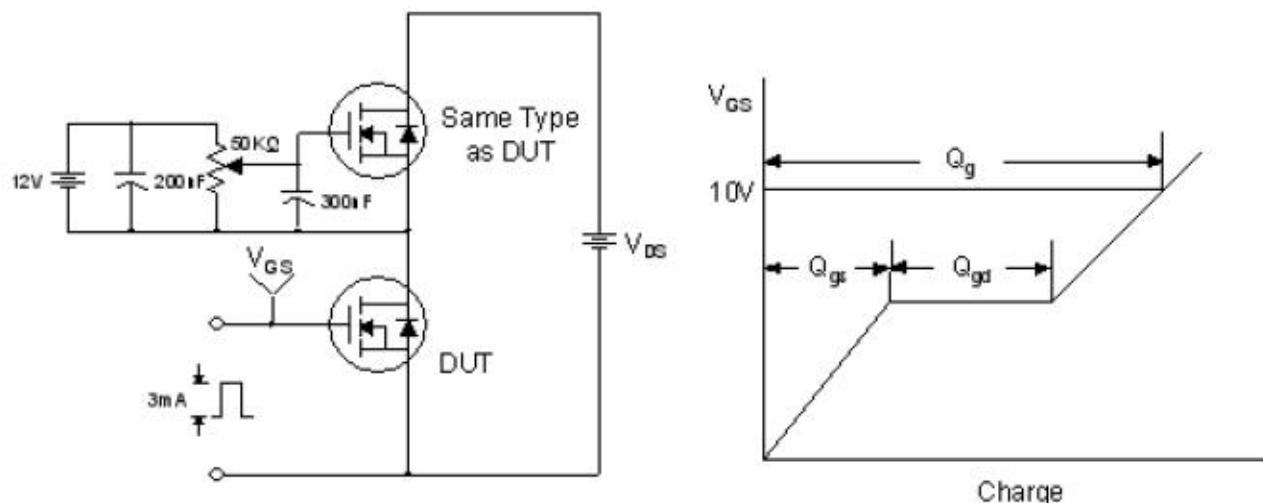


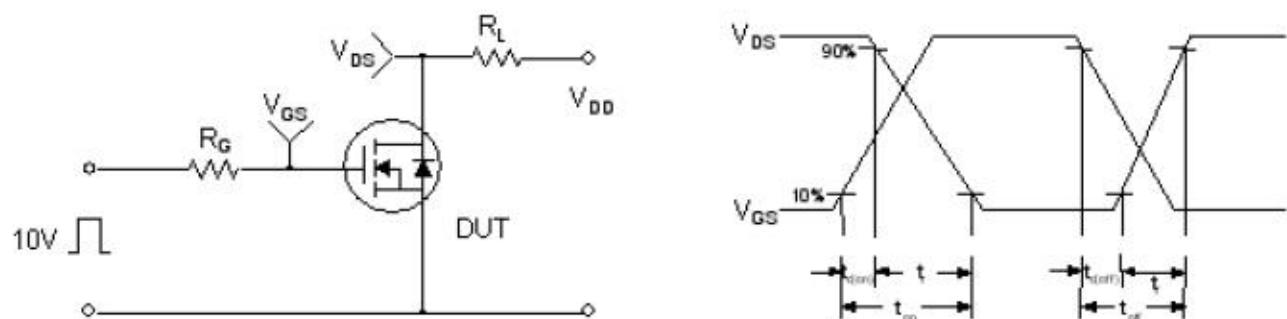
Figure 11. Transient Thermal Response Curve



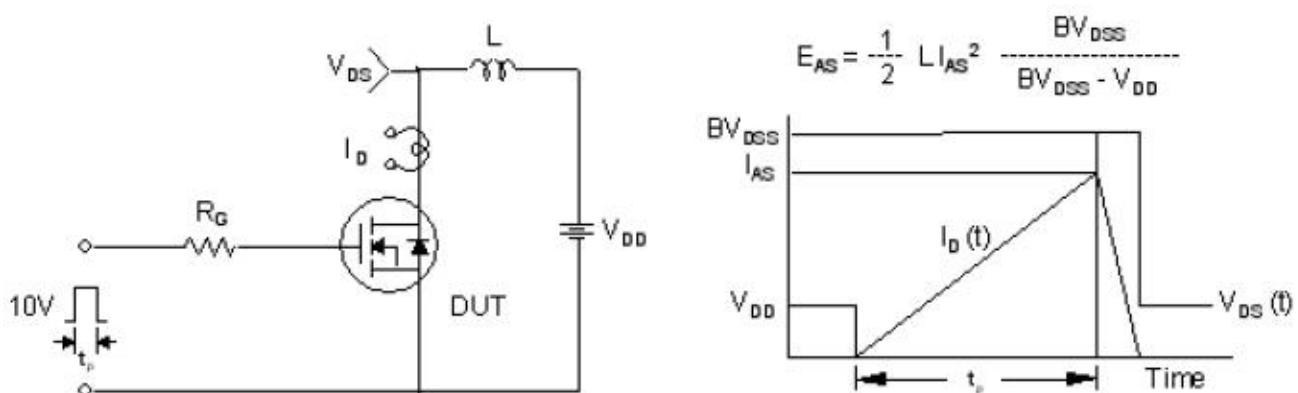
Gate Charge Test Circuit & Waveform



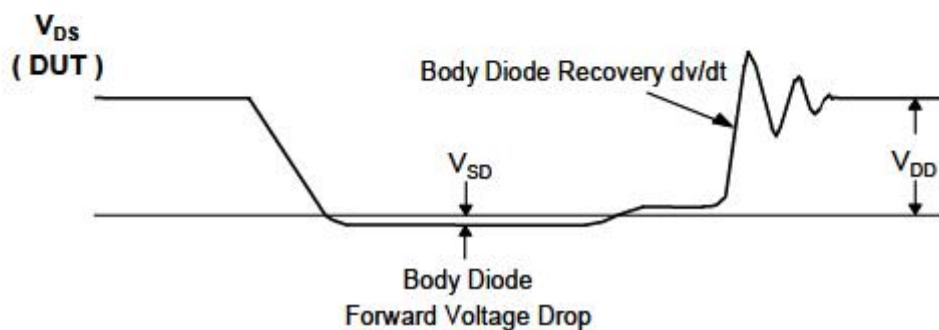
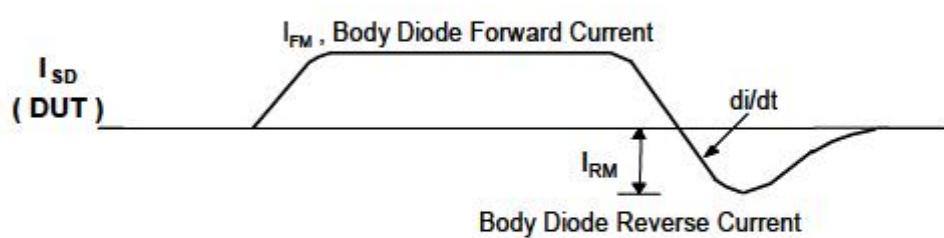
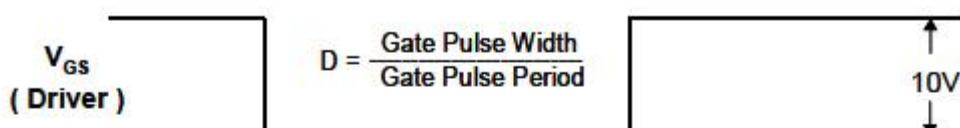
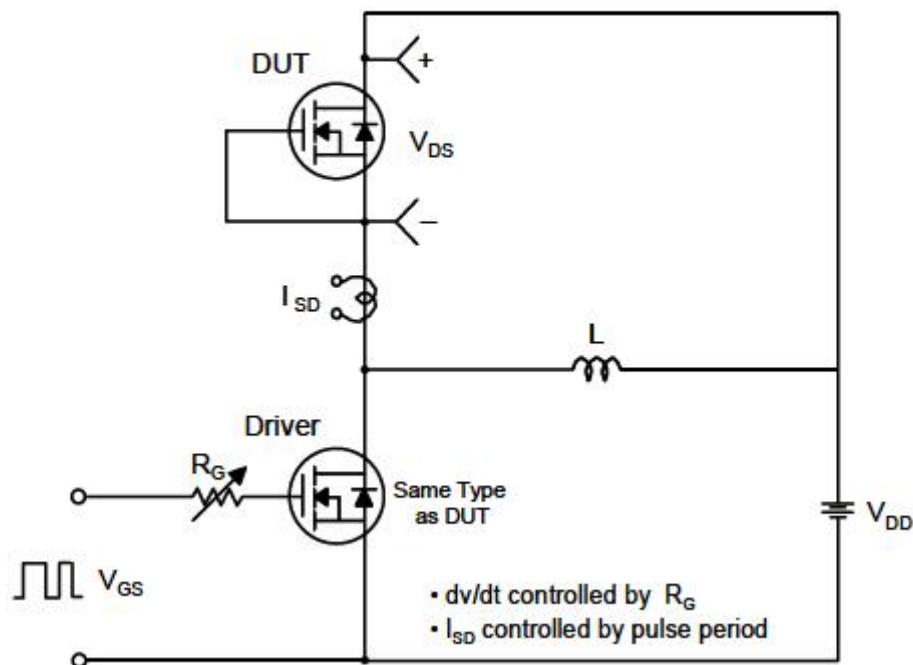
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms



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